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April 1st, 2010 Renesas Electronics Corporation

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DATA SHEET

BIPOLAR ANALOG INTEGRATED CIRCUIT $\mu PC3219GV$

GENERAL PURPOSE 5 V 100 MHz AGC AMPLIFIER

DESCRIPTION

The μ PC3219GV is a silicon monolithic IC designed for use as AGC amplifier for digital CATV, cable modem systems. This IC consists of gain control amplifier and video amplifier.

The package is 8-pin SSOP suitable for surface mount.

This IC is manufactured using our 10 GHz fr NESAT II AL silicon bipolar process. This process uses silicon nitride passivation film. This material can protect chip surface from external pollution and prevent corrosion/migration. Thus, this IC has excellent performance, uniformity and reliability.

FEATURES

- Low distortion : $IM_3 = 58 \text{ dBc TYP}$. @ single-ended output, $V_{out} = 0.7 V_{p-p}/tone$
- Wide AGC dynamic range : GCR = 42.5 dB TYP.
- On-chip video amplifier : Vout = 1.0 Vp-p TYP. @ single-ended output
- Supply voltage : Vcc = 5.0 V TYP.
- Packaged in 8-pin SSOP suitable for surface mounting

APPLICATION

• Digital CATV/Cable modem receivers

ORDERING INFORMATION

Part Number	Package	Marking	Supplying Form
μΡC3219GV-E1	8-pin plastic SSOP (4.45 mm (175))	3219	 Embossed tape 8 mm wide Pin 1 indicates pull-out direction of tape Qty 1 kpcs/reel

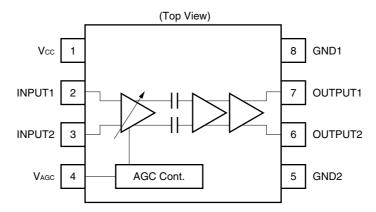
Remark To order evaluation samples, contact your nearby sales office. Part number for sample order: μ PC3219GV

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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Document No. PU10511EJ01V0DS (1st edition) (Previous No. P15434EJ1V0DS00) Date Published August 2004 CP(K) Printed in Japan The mark \star shows major revised points.

INTERNAL BLOCK DIAGRAM AND PIN CONNECTIONS



PRODUCT LINE-UP OF 5 V AGC AMPLIFIER

Part Number	lcc (mA)	Gмах (dB)	Gміn (dB)	GCR (dB)	NF (dB)	IM₃ (dBc) ^{№te}	Package
μPC3217GV	23	53	0	53	6.5	50	8-pin SSOP (4.45 mm (175))
μPC3218GV	23	63	10	53	3.5	50	
μPC3219GV	36.5	42.5	0	42.5	9.0	58	

Note $f_1 = 44$ MHz, $f_2 = 45$ MHz, $V_{out} = 0.7$ V_{p-p}/tone, single-ended output

PIN EXPLANATIONS

Pin No.	Pin Name	Applied Voltage (V)	Pin Voltage (V) ^{∾ote}	Function and Application	Internal Equivalent Circuit
1	Vcc	4.5 to 5.5	-	Power supply pin. This pin should be externally equipped with bypass capacitor to minimize ground impedance.	
2	INPUT1	_	1.45	Signal input pins to AGC amplifier. This pin should be coupled with capacitor for DC cut.	AGC AGC
3	INPUT2	_	1.45		
4	Vage	0 to Vcc	_	Gain control pin. This pin's bias govern the AGC output level. Minimum Gain at V _{AGC} < 0.5 V Maximum Gain at V _{AGC} > 4.5 V Recommended to use AGC voltage with externally resister (example:100 kΩ).	AGC Amp. S
5	GND2	0	_	Ground pin. This pin should be connected to system ground with minimum inductance. Ground pattern on the board should be formed as wide as possible.	
6	OUTPUT2	_	2.2	Signal output pins of video amplifier. This pin should be coupled with capacitor for DC cut.	
7	OUTPUT1	_	2.2		
8	GND1	0	_	Ground pin. This pin should be connected to system ground with minimum inductance. Ground pattern on the board should be formed as wide as possible. All ground pins must be connected together with wide ground pattern to decrease impedance difference.	

Note Pin voltage is measured at Vcc = 5.0 V.

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Test Conditions	Ratings	Unit
Supply Voltage	Vcc	T _A = +25°C	6.0	V
Power Dissipation	PD	T _A = +85°C Note	250	mW
Operating Ambient Temperature	TA		-40 to +85	°C
Storage Temperature	Tstg		–55 to +150	°C

Note Mounted on double-sided copper-clad 50 \times 50 \times 1.6 mm epoxy glass PWB

RECOMMENDED OPERATING RANGE

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Supply Voltage	Vcc		4.5	5.0	5.5	V
Operating Ambient Temperature	TA	Vcc = 4.5 to 5.5 V	-40	+25	+85	°C
Gain Control Voltage Range	VAGC		0	-	Vcc	V
Operating Frequency Range	fвw		10	45	100	MHz

ELECTRICAL CHARACTERISTICS

(TA = +25°C, Vcc = 5 V, f = 45 MHz, Zs = 50 Ω , ZL = 250 Ω , single-ended output)

Parameter	Symbol	Test Conditions		MIN.	TYP.	MAX.	Unit
DC Characteristics							
Circuit Current	lcc	No input signal	Note 1	27.5	36.5	43.5	mA
AGC Voltage High Level	VAGC (H)	@ Maximum gain	Note 1	4.5	-	Vcc	V
AGC Voltage Low Level	VAGC (L)	@ Minimum gain	Note 1	0	-	0.5	V
RF Characteristics							
Maximum Voltage Gain	Gмах	$V_{AGC} = 4.5 \text{ V}, \text{ Pin} = -40 \text{ dBm}$	Note 1	39	42.5	45	dB
Minimum Voltage Gain	Gmin	$V_{AGC} = 0.5 V$, $P_{in} = -20 dBm$	Note 1	-4	0	4	dB
Gain Control Range	GCR	V _{AGC} = 0.5 to 4.5 V	Note 1	35	42.5	-	dB
Output Voltage	Vout	P _{in} = -38 to -13 dBm	Note 1	-	1.0	_	V _{p-p}
Maximum Output Voltage	Voclip	VAGC = 4.5 V @ Maximum gai	n Note 1	2.5	3.4	-	V _{p-p}
Noise Figure	NF	VAGC = 4.5 V @ Maximum gai	n Note 2	-	9.0	10.5	dB

Notes 1. By measurement circuit 1

2. By measurement circuit 2

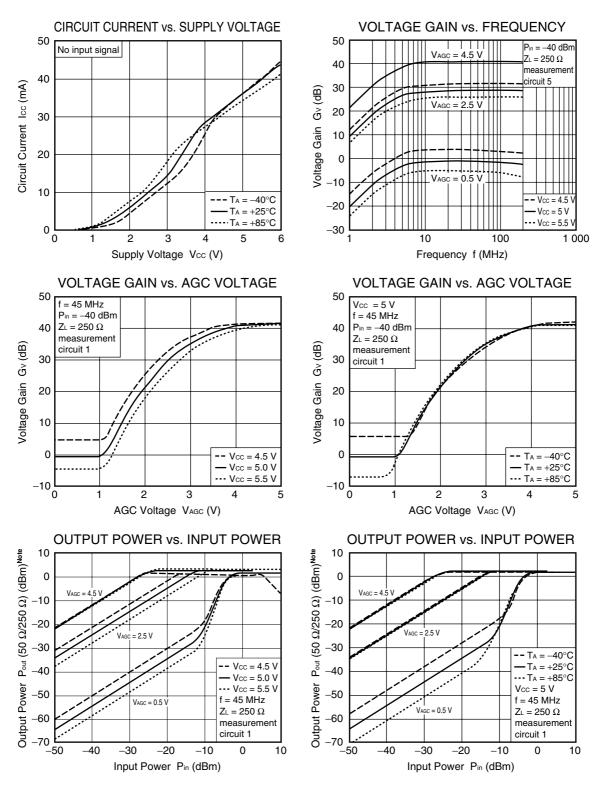
STANDARD CHARACTERISTICS (TA = +25°C, Vcc = 5 V, Zs = 50 Ω)

Parameter	Symbol	Test Conditions	Reference Value	Unit
Input Impedance	Zin	V _{AGC} = 0.5 V, f = 45 MHz Note 1	1.2 k – j1.5 k	Ω
Output Impedance	Zout	V _{AGC} = 0.5 V, f = 45 MHz Note 1	6.0 + j3.2	Ω
3rd Order Input Intercept Point	IIP3	$\label{eq:AGC} \begin{array}{l} V_{AGC} = 0.5 \ V \ @ \ Minimum \ gain, \\ f_1 = 44 \ MHz, \ f_2 = 45 \ MHz, \\ Z_L = 250 \ \Omega \ @ \ single-ended \ output \\ \hline \ Note \ 2 \end{array}$	-1	dBm
3rd Order Intermodulation Distortion 1	IM₃1		52	dBc
3rd Order Intermodulation Distortion 2	IM32	$ f_1 = 44 \text{ MHz}, f_2 = 45 \text{ MHz}, Z_L = 250 \ \Omega, \\ P_{in} = -40 \text{ to} -23 \text{ dBm/tone}, \\ V_{out} = 0.7 \ V_{P\text{-}P}/\text{tone} \ @ \text{single-ended} \\ \text{output} \qquad \qquad \text{Note 2} $	58	dBc
3rd Order Intermodulation Distortion 3	IM₃3	$ f_1 = 44 \text{ MHz}, f_2 = 45 \text{ MHz}, Z_L = 500 \ \Omega, \\ P_{\text{in}} = -37 \text{ to} -20 \text{ dBm/tone}, \\ V_{\text{out}} = 2.0 \text{ V}_{\text{P-P}}/\text{tone @ differential output} \\ \textbf{Note 3} $	52	dBc
3rd Order Intermodulation Distortion 4	IM34	$ f_1 = 44 \text{ MHz}, f_2 = 45 \text{ MHz}, Z_L = 500 \ \Omega, \\ P_{\text{in}} = -40 \text{ to} -23 \text{ dBm/tone}, \\ V_{\text{out}} = 1.4 \text{ V}_{\text{P-P}}/\text{tone @ differential output} \\ \textbf{Note 3} $	58	dBc
2nd Order Intermodulation Distortion 1	IM21	$ f_1 = 44 \text{ MHz}, f_2 = 45 \text{ MHz}, Z_L = 500 \ \Omega, \\ P_{in} = -37 \text{ to} -22 \text{ dBm/tone}, \\ V_{out} = 2.0 \ V_{P\text{-}P}/\text{tone} \ @ \text{differential output} \\ \textbf{Note 3} $	45	dBc
2nd Order Intermodulation Distortion 2	IM22	$ f_1 = 44 \text{ MHz}, f_2 = 45 \text{ MHz}, Z_L = 500 \ \Omega, \\ P_{in} = -40 \text{ to} -23 \text{ dBm/tone}, \\ V_{out} = 1.4 \text{ V}_{P\text{-P}}/\text{tone @ differential output} \\ \textbf{Note 3} $	47	dBc

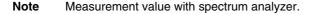
Notes 1. By measurement circuit 3

2. By measurement circuit 1

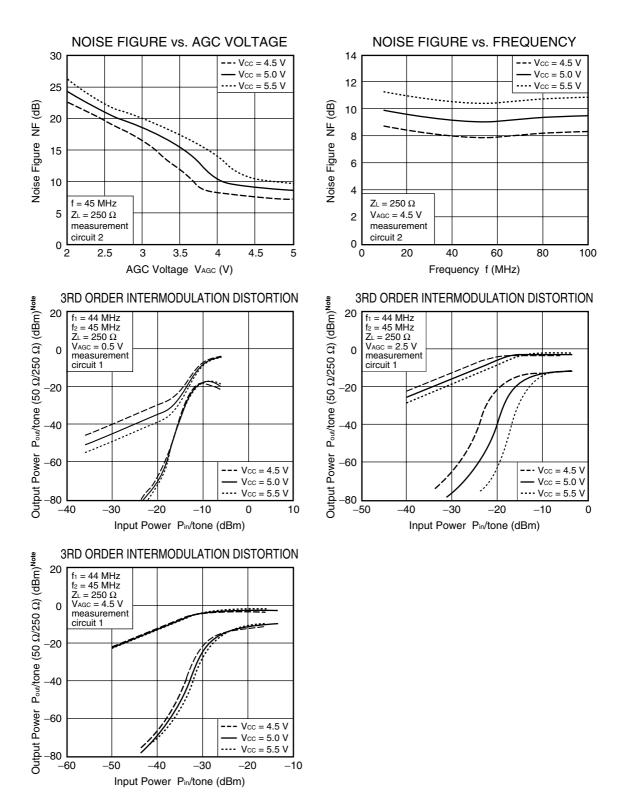
3. By measurement circuit 4



TYPICAL CHARACTERISTICS (TA = +25°C, unless otherwise specified)

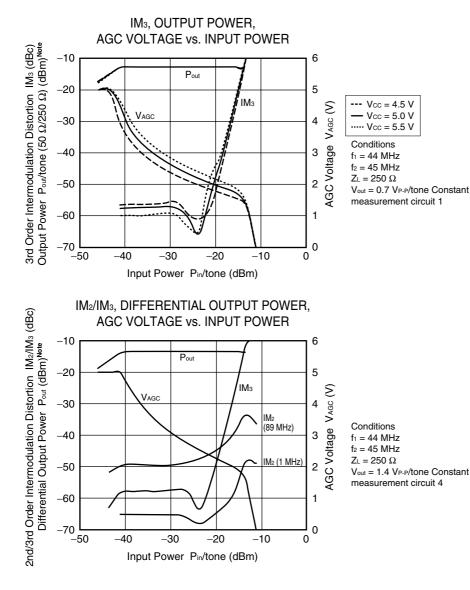


Remark The graphs indicate nominal characteristics.



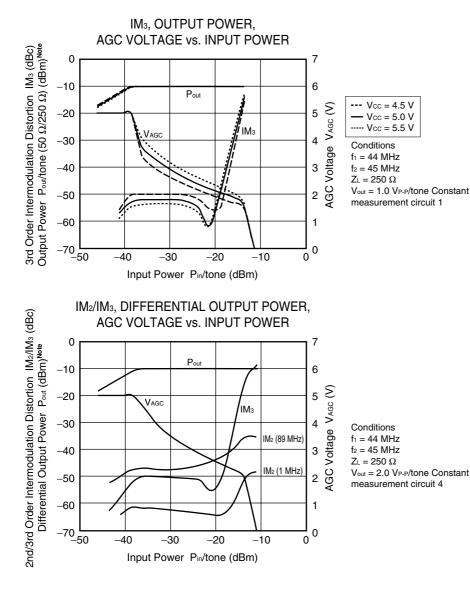
Note Measurement value with spectrum analyzer.

Remark The graphs indicate nominal characteristics.



Note Measurement value with spectrum analyzer.

Remark The graphs indicate nominal characteristics.

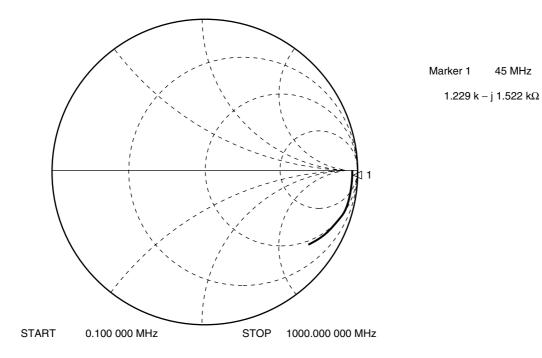


Note Measurement value with spectrum analyzer.

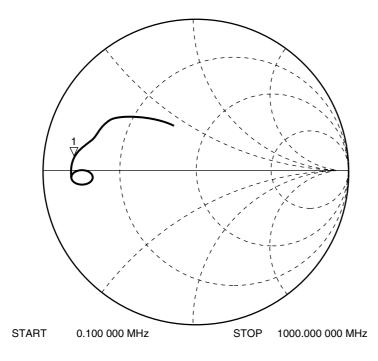
Remark The graphs indicate nominal characteristics.

S-PARAMETERS (TA = +25°C, Vcc = 5.0 V)

S11-FREQUENCY

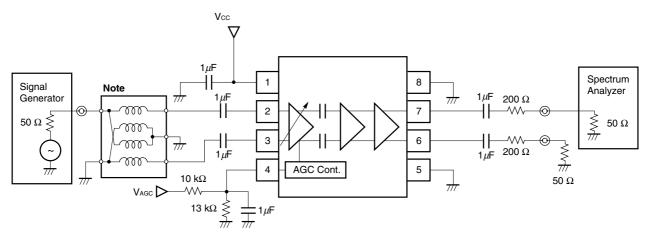


S22-FREQUENCY



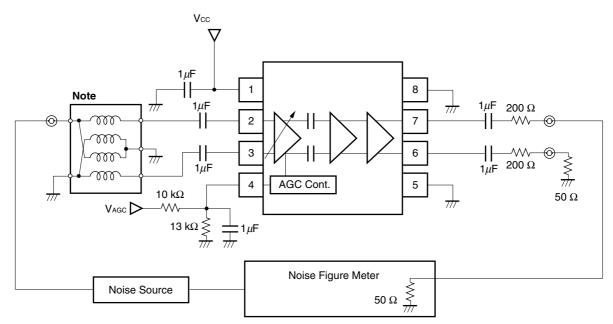
Marker 1 45 MHz 6.035 + j 3.157 Ω

MEASUREMENT CIRCUIT 1



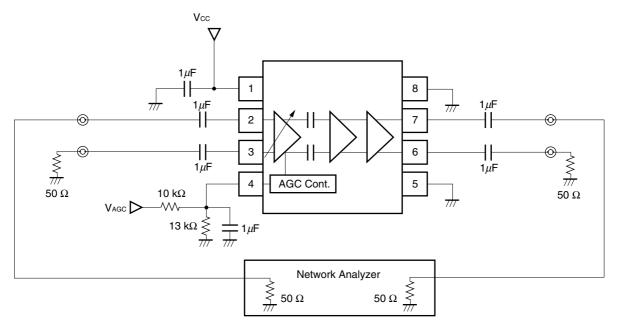
Note Balun Transformer: TOKO 617DB-1010 B4F (Double balanced type)

MEASUREMENT CIRCUIT 2

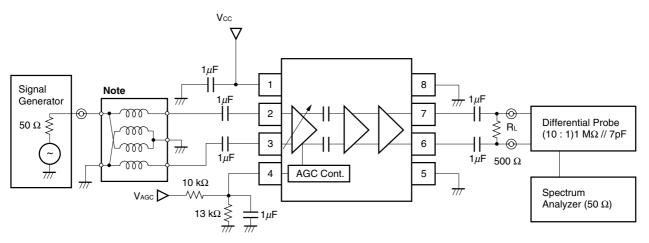


Note Balun Transformer: TOKO 617DB-1010 B4F (Double balanced type)

MEASUREMENT CIRCUIT 3

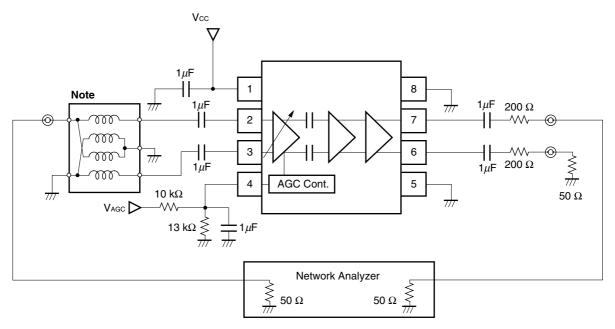


MEASUREMENT CIRCUIT 4



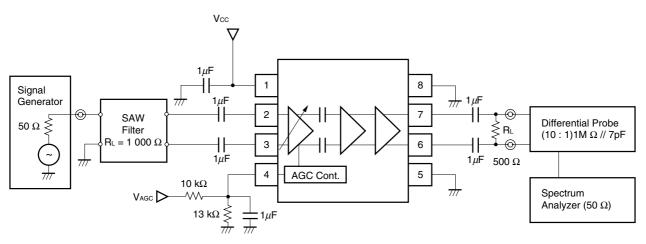
Note Balun Transformer: TOKO 617DB-1010 B4F (Double balanced type)

MEASUREMENT CIRCUIT 5



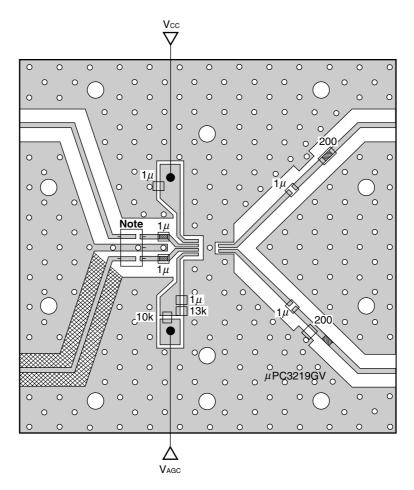
Note Balun Transformer: TOKO 617DB-1010 B4F (Double balanced type)

APPLICATION CIRCUIT EXAMPLE



The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

ILLUSTRATION OF THE EVALUATION BOARD FOR MEASUREMENT CIRCUIT 1

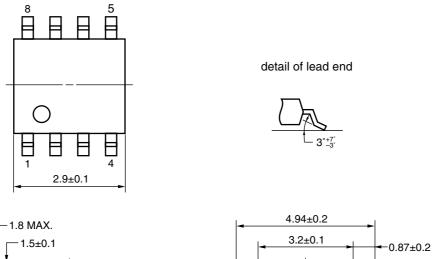


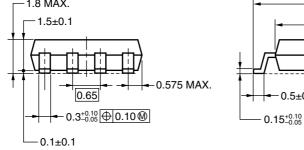
Note Balun Transformer

- Remarks 1. Back side: GND pattern
 - 2. Solder plated on pattern
 - 3. oO: Through holes
 - 4. represents cutout
 - 5. cepresents short-circuit strip

PACKAGE DIMENSIONS *

8-PIN PLASTIC SSOP (4.45 mm (175)) (UNIT: mm)







0.5±0.2

0.15

NOTES ON CORRECT USE

- (1) Observe precautions for handling because of electro-static sensitive devices.
- (2) Form a ground pattern as widely as possible to minimize ground impedance (to prevent undesired oscillation). All the ground pins must be connected together with wide ground pattern to decrease impedance difference.
- (3) The bypass capacitor should be attached to Vcc line.

★ RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
VPS ^{Note}	Peak temperature (package surface temperature) Time at temperature of 200°C or higher Preheating time at 120 to 150°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 215°C or below : 25 to 40 seconds : 30 to 60 seconds : 3 times : 0.2%(Wt.) or below	VP215
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (pin temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	H\$350

Note Excluding lead-free products

Caution Do not use different soldering methods together (except for partial heating).

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